## NRE-4000, NRE-3000, NRP-4000, and NDR-4000 RIE SYSTEMS







NRE Chamber

NRE-4000

### **Description:**

The NRE-4000 is a stand-alone Reactive Ion Etching (RIE) system with shower-head gas distribution and a water cooled RF platen. It has a stainless steel cabinet and a 13" cylindrical Aluminum chamber that opens from top for wafer loading. Chamber has two ports one with a 2" window the other with a blank off for end point detection and for other diagnostic. It can accept up to 8" wafers. Chamber is extremely clean in design and reaches 10<sup>-6</sup> Torr or lower base pressure depending on the pumping package. It can be operated in the pressure range of 20 mTorr to 8 Torr. Pumping package consists of a throttle valve, 300L/sec corrosive turbomolecular pump, sieve filter, and a 10cfm mechanical pump with Fomblin oil. For process pressure monitoring heated Baratron® is used. The RF power is provided by 600 W 13.5 MHz power supply, and 1000 W auto-tuner. The self DC bias is continuously monitored and reaches as high as -500 V which is important for anisotropic etching. The system is completely automated and is PC controlled. MFC's, valves, and the cover lift are pneumatic and controlled through PC. The real time system pressure and DC bias is displayed in graphic format while flow and power is displayed in alpha numeric format. Three levels of authorization Auto, Engineering, and Maintenance prevents unauthorized use of the system while giving maximum flexibility to user for setting up recipes in Engineering mode and running in Auto mode reproducibly.

The NRE-3000 is a table top Reactive Ion System. Chamber, gas distribution plate, RF platen are same as the stand alone version. It is again completely PC controlled, except in this table-top unit certain options can not be provided due to space constraints. For example, it does not use any throttle valve and the pressure is set with flow. Maximum number of MFC's is four, and no sieve filter is provided.

The NRP-4000 is a Dual Reactive Ion Etching and Plasma Enhanced Chemical Vapor Deposition System. It has the same footprint as NRE-4000 or NPE-4000 (stand alone PECVD system, see brochure), but combines complete deposition and etching capabilities of two separate systems by having two chambers and a common pumping and power delivery package. Chambers are isolated with pneumatically controlled gate valves. Both systems are controlled through same PC and one or the other chamber can be run at a time.

The NDR-4000 is Deep Reactive Ion Etching System with cryogenic wafer cooling and biasable platen and a 8" Inductively Coupled Plasma Source. It has 500L/sec turbo and process pressures can be as low as few mTorr.

### **Reactive Etching System Options:**

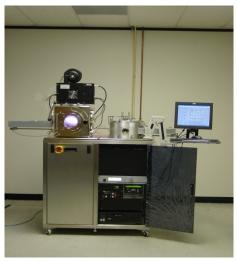
- Plasma Etch Mode: RF Gas distribution plate for Isotropic etching (capable of switching from plasma to RIE mode during process)
- ICP Plasma Source, 2KW RF Power Supply and Tuner
- Substrate heating up to 200 C
- Cryogenic Substrate Cooling
- End Point Detection
- Langmuir Probe
- Electrostatic Chuck
- Additional MFC's
- 1KW Power RF power supply and tuner
- Lower frequency power supplies and tuners
- Load Lock



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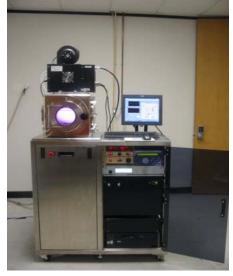
# NRE-4000, NRE-3000, NRP-4000, and NDR-4000 RIE SYSTEMS



NRP-4000 Dual PECVD/RIE System With ICP source and Auto Load/Unload



**Nano-Master Shower Head RF Plasma Source** 



NDR-4000 with SS Chamber and P-200 ICP Source

## **Reactive Etching System Specifications:**

**NRE** 

Control: PC, Lab View

13" Aluminum, solid block Chamber:

Substrate Holder: 13 °C, water cooled

Shower Head, MFC's, SS lines Gas Distribution: RF Platen, P-100 (Hollow Cathode) Plasma Source

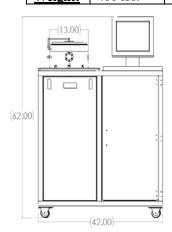
up to -500V Self Bias DC Bias:

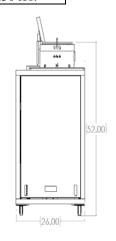
5x10<sup>-7</sup> Torr Base Pressure: 0.02-8 Torr Process Pressure:

RF Power: 600 W, 1000W Optional 200 L/sec Corrosive Turbo Vacuum Pump: Mechanical pump: RV 12 with Fomblin Oil Power: 110/220V 3Phase, 40/20A

### **Dimensions and Weight:**

	NRE-4000	NRP-4000	NRE-3000
Length:	42"	42"	30"
Width:	26"	26"	26"
Height:	62"	62"	26"
Weight:	400 lbs.	600 lbs.	250 lbs.





### **NDR**

PC, Lab View

13" Aluminum, solid block/SS Cubic Chamber

-60 °C, Cryogenic/electrostatic chuck

Gas Ring, MFC's, SS lines

Planar ICP 200 (8")

up to -1000 V external bias

5x10<sup>-7</sup> Torr 0.001 Torr and up 600W, or 1KW

260 L/sec Corrosive Turbo/500 L/sec optional RV 12 with Fomblin Oil/Dry Scroll Pump

110/220V 3Phase, 40/20



NRE-3000

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